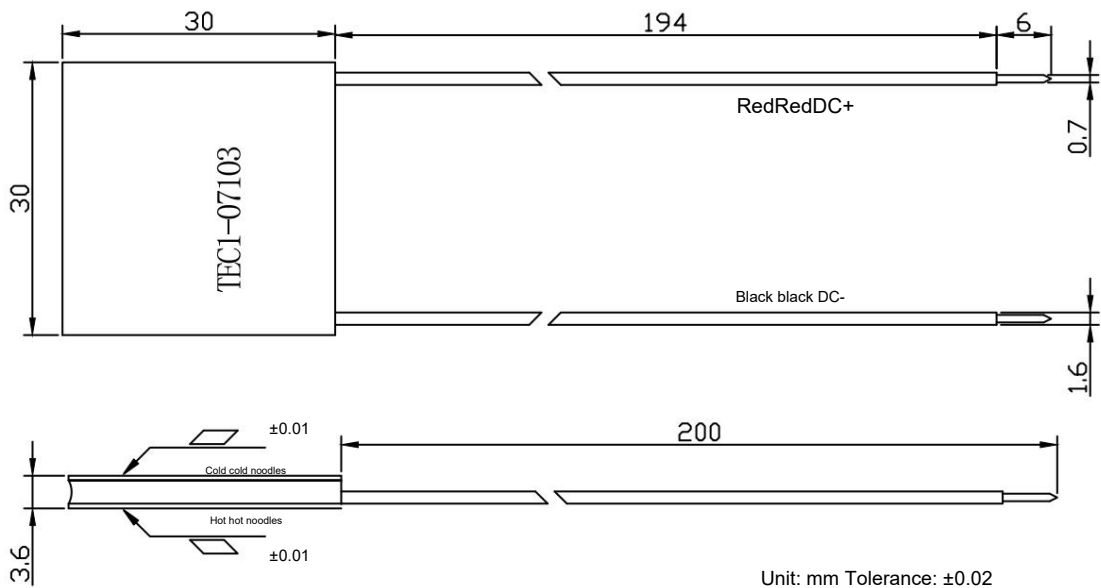


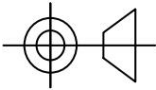
Semiconductor refrigeration chip specifications

TEC1-07103

1. Dimensions



2. Performance indicators

Product	Model	TEC1-07103	Dimensions	Size	30x30x3.6mm	
Maximum voltage	Vmax	DC8.4V	Internal resistance	Impe	2.18Ω	
Maximum current	Imax	3.0A	Solder type	Solder	Bi67+Sn33	
Maximum temperature difference	DTmax	60℃	Packaging material	Imax	96% alumina+CU2	
Input power	Wmax	25W	Sealing material	Seal up	704 silicone rubber	
Cooling capacity	Cool	15W	Lead specifications Wire standard	Wire gauge	length	terminal
Maximum temperature resistance	Kmax	≤150℃		UL1007	+Red 200	NO
				22AGW	-Black 200	
Thermoelectric Cooler			Making orders	Name	Huang Dong	
			Update date	Date	2023-01-07	